

# WEST Search History for Application 10817265

Creation Date: 2009082110:34

## Prior Art Searches

Query	DB	Op.	Plur.	Thes.	Date
(374/001, 1, 170, 171, 172, 173, 178;327/512, 513;324/759, 760, 761, 762, 763, 764, 765, 766, 767, 768, 769;702/130, 131, 132, 133, 134, 135, 136, 99)! [CCLS]	PGPB, USPT, USOC, EPAB, JPAB	ADJ	YES		08-21-2009
(pad or contact or pin or terminal) near (thermal\$3 near diode or thermal near transistor or temperature near transistor or temperature near diode or thermal near junction or temperature near junction or sens\$5 near junction) and (integrated circuit or IC or chip or die or semiconductor or substrate or printed near board or circuit near board or PCB)	PGPB, USPT, USOC, EPAB, JPAB	ADJ	YES		08-21-2009
((pad or contact or pin or terminal) near (thermal\$3 near diode or thermal near transistor or temperature near transistor or temperature near diode or thermal near junction or temperature near junction or sens\$5 near junction) and (integrated circuit or IC or chip or die or semiconductor or substrate or printed near board or circuit near board or PCB) ) and ((374/001, 1, 170, 171, 172, 173, 178;327/512, 513;324/759, 760, 761, 762, 763, 764, 765, 766, 767, 768, 769;702/130, 131, 132, 133, 134, 135, 136, 99)! [CCLS] )	PGPB, USPT, USOC, EPAB, JPAB	ADJ	YES		08-21-2009
((pad or contact or pin or terminal) near (thermal\$3 near diode or thermal near transistor or temperature near transistor or temperature near diode or thermal near junction or temperature near junction or sens\$5 near junction) and (integrated circuit or IC or chip or die or semiconductor or substrate or printed near board or circuit near board or PCB) ) and (constant current)	PGPB, USPT, USOC, EPAB, JPAB	ADJ	YES		08-21-2009
(pad or contact or pin or terminal) same (thermal\$3 near diode or thermal near transistor or temperature near transistor or temperature near diode or thermal near junction or temperature near junction or sens\$5 near junction) and (integrated circuit or IC or chip or die or semiconductor or substrate or printed near board or circuit near board or PCB)	PGPB, USPT, USOC, EPAB, JPAB	ADJ	YES		08-21-2009
		ADJ	YES		08-21-2009

((pad or contact or pin or terminal) same (thermal\$3 near diode or thermal near transistor or temperature near transistor or temperature near diode or thermal near junction or temperature near junction or sens\$5 near junction) and (integrated circuit or IC or chip or die or semiconductor or substrate or printed near board or circuit near board or PCB) ) and ((374/001, 1, 170, 171, 172, 173, 178;327/512, 513;324/759, 760, 761, 762, 763, 764, 765, 766, 767, 768, 769;702/130, 131, 132, 133, 134, 135, 136, 99)![CCLS] )	PGPB, USPT, USOC, EPAB, JPAB				
((pad or contact or pin or terminal) same (thermal\$3 near diode or thermal near transistor or temperature near transistor or temperature near diode or thermal near junction or temperature near junction or sens\$5 near junction) and (integrated circuit or IC or chip or die or semiconductor or substrate or printed near board or circuit near board or PCB) and (374/001, 1, 170, 171, 172, 173, 178;327/512, 513;324/759, 760, 761, 762, 763, 764, 765, 766, 767, 768, 769;702/130, 131, 132, 133, 134, 135, 136, 99)![CCLS] ) and (bias\$3 or forward near bias\$3)	PGPB, USPT, USOC, EPAB, JPAB	ADJ	YES		08-21-2009
((pad or contact or pin or terminal) same (thermal\$3 near diode or thermal near transistor or temperature near transistor or temperature near diode or thermal near junction or temperature near junction or sens\$5 near junction) and (integrated circuit or IC or chip or die or semiconductor or substrate or printed near board or circuit near board or PCB) and (374/001, 1, 170, 171, 172, 173, 178;327/512, 513;324/759, 760, 761, 762, 763, 764, 765, 766, 767, 768, 769;702/130, 131, 132, 133, 134, 135, 136, 99)![CCLS] and (bias\$3 or forward near bias\$3) ) and (constant near current)	PGPB, USPT, USOC, EPAB, JPAB	ADJ	YES		08-21-2009